



# AD7537- SPECIFICATIONS

( $V_{DD} = +12\text{ V to } +15\text{ V}, \pm 10\%$ ,  $V_{REFA} = V_{REFB} = 10\text{ V}$ ;  $I_{OUTA} = \text{AGND} = 0\text{ V}$ ,  
 $I_{OUTB} = \text{AGNDB} = 0\text{ V}$ . All specifications  $T_{MIN}$  to  $T_{MAX}$  unless otherwise noted.)

Parameter	J, A Versions	K, B Versions	L, C Versions	S Version	T Version	U Version	Units	Test Conditions/Comments
ACCURACY								
Resolution	12	12	12	12	12	12	Bits	
Relative Accuracy	$\pm 1$	$\pm 1/2$	$\pm 1/2$	$\pm 1$	$\pm 1/2$	$\pm 1/2$	LSB max	
Differential Nonlinearity	$\pm 1$	$\pm 1$	$\pm 1$	$\pm 1$	$\pm 1$	$\pm 1$	LSB max	All grades guaranteed monotonic over temperature.
Gain Error	$\pm 6$	$\pm 3$	$\pm 1$	$\pm 6$	$\pm 3$	$\pm 2$	LSB max	Measured using $R_{FBA}$ , $R_{FBB}$ . Both DAC registers loaded with all 1s.
Gain Temperature Coefficient <sup>2</sup> ; $\Delta\text{Gain}/\Delta\text{Temperature}$	$\pm 5$	$\pm 5$	$\pm 5$	$\pm 5$	$\pm 5$	$\pm 5$	ppm/°C max	Typical value is 1 ppm/°C
Output Leakage Current								
$I_{OUTA}$ +25°C	10	10	10	10	10	10	nA max	DAC A Register loaded with all 0s
$T_{MIN}$ to $T_{MAX}$	150	150	150	250	250	250	nA max	
$I_{OUTB}$ +25°C	10	10	10	10	10	10	nA max	DAC B Register loaded with all 0s
$T_{MIN}$ to $T_{MAX}$	150	150	150	250	250	250	nA max	
REFERENCE INPUT								
Input Resistance	9 20	9 20	9 20	9 20	9 20	9 20	k $\Omega$ min k $\Omega$ max	Typical Input Resistance = 14 k $\Omega$
$V_{REFA}$ , $V_{REFB}$ Input Resistance Match	$\pm 3$	$\pm 3$	$\pm 1$	$\pm 3$	$\pm 3$	$\pm 1$	% max	Typically $\pm 0.5\%$
DIGITAL INPUTS								
$V_{IH}$ (Input High Voltage)	2.4	2.4	2.4	2.4	2.4	2.4	V min	
$V_{IL}$ (Input Low Voltage)	0.8	0.8	0.8	0.8	0.8	0.8	V max	
$I_{IN}$ (Input Current)								
+25°C	$\pm 1$	$\pm 1$	$\pm 1$	$\pm 1$	$\pm 1$	$\pm 1$	$\mu\text{A}$ max	$V_{IN} = V_{DD}$
$T_{MIN}$ to $T_{MAX}$	$\pm 10$	$\pm 10$	$\pm 10$	$\pm 10$	$\pm 10$	$\pm 10$	$\mu\text{A}$ max	
$C_{IN}$ (Input Capacitance) <sup>2</sup>	10	10	10	10	10	10	pF max	
POWER SUPPLY <sup>3</sup>								
$V_{DD}$	10.8/16.5	10.8/16.5	10.8/16.5	10.8/16.5	10.8/16.5	10.8/16.5	V min/V max	
$I_{DD}$	2	2	2	2	2	2	mA max	

## AC PERFORMANCE CHARACTERISTICS

These characteristics are included for Design Guidance only and are not subject to test.

( $V_{DD} = +12\text{ V to } +15\text{ V}$ ;  $V_{REFA} = V_{REFB} = +10\text{ V}$ ;  $I_{OUTA} = \text{AGNDA} = 0\text{ V}$ ,  $I_{OUTB} = \text{AGNDB} = 0\text{ V}$ . Output Amplifiers are AD644 except where noted.)

Parameter	$T_A = +25^\circ\text{C}$	$T_A = T_{MIN}, T_{MAX}$	Units	Test Conditions/Comments
Output Current Settling Time	1.5		$\mu\text{s}$ max	To 0.01% of full-scale range. $I_{OUT}$ load = 100 $\Omega$ , $C_{EXT} = 13\text{ pF}$ . DAC output measured from falling edge of $\overline{WR}$ . Typical Value of Settling Time is 0.8 $\mu\text{s}$ .
Digital-to-Analog Glitch Impulse	7		nV-s typ	Measured with $V_{REFA} = V_{REFB} = 0\text{ V}$ . $I_{OUTA}$ , $I_{OUTB}$ load = 100 $\Omega$ , $C_{EXT} = 13\text{ pF}$ . DAC registers alternately loaded with all 0s and all 1s.
AC Feedthrough <sup>4</sup>				
$V_{REFA}$ to $I_{OUTA}$	-70	-65	dB max	$V_{REFA}$ , $V_{REFB} = 20\text{ V p-p } 10\text{ kHz}$ sine wave.
$V_{REFB}$ to $I_{OUTB}$	-70	-65	dB max	DAC registers loaded with all 0s.
Power Supply Rejection				
$\Delta\text{Gain}/\Delta V_{DD}$	$\pm 0.01$	$\pm 0.02$	% per % max	$\Delta V_{DD} = V_{DD\text{ max}} - V_{DD\text{ min}}$
Output Capacitance				
$C_{OUTA}$	70	70	pF max	DAC A, DAC B loaded with all 0s
$C_{OUTB}$	70	70	pF max	
$C_{OUTA}$	140	140	pF max	DAC A, DAC B loaded with all 1s
$C_{OUTB}$	140	140	pF max	
Channel-to-Channel Isolation				
$V_{REFA}$ to $I_{OUTB}$	-84		dB typ	$V_{REFA} = 20\text{ V p-p } 10\text{ kHz}$ sine wave, $V_{REFB} = 0\text{ V}$ . Both DACs loaded with all 1s.
$V_{REFB}$ to $I_{OUTA}$	-84		dB typ	$V_{REFB} = 20\text{ V p-p } 10\text{ kHz}$ sine wave, $V_{REFA} = 0\text{ V}$ . Both DACs loaded with all 1s.
Digital Crosstalk	7		nV-s typ	Measured for a Code Transition of all 0s to all 1s. $I_{OUTA}$ , $I_{OUTB}$ load = 100 $\Omega$ , $C_{EXT} = 13\text{ pF}$ .
Output Noise Voltage Density (10 Hz–100 kHz)	25		nV/ $\sqrt{\text{Hz}}$ typ	Measured between $R_{FBA}$ and $I_{OUTA}$ or $R_{FBB}$ and $I_{OUTB}$ . Frequency of measurement is 10 Hz–100 kHz.
Total Harmonic Distortion	-82		dB typ	$V_{IN} = 6\text{ V rms}$ , 1 kHz. Both DACs loaded with all 1s.

### NOTES

<sup>1</sup>Temperature range as follows: J, K, L Versions: -40°C to +85°C;  
A, B, C Versions: -40°C to +85°C;  
S, T, U Versions: -55°C to +125°C

Specifications subject to change without notice.

<sup>2</sup>Sample tested at +25°C to ensure compliance.

<sup>3</sup>Functional at  $V_{DD} = 5\text{ V}$ , with degraded specifications.

<sup>4</sup>Pin 12 (DGND) on ceramic DIPs is connected to lid.

# TIMING CHARACTERISTICS ( $V_{DD} = +10.8\text{ V to } +16.5\text{ V}$ , $V_{REFA} = V_{REFB} = +10\text{ V}$ ; $I_{OUTA} = \text{AGNDA} = 0\text{ V}$ , $I_{OUTB} = \text{AGNDB} = 0\text{ V}$ .)

Parameter	Limit at $T_A = +25^\circ\text{C}$	Limit at $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$	Limit at $T_A = +55^\circ\text{C}$ to $+125^\circ\text{C}$	Units	Test Conditions/Comments
$t_1$	15	15	30	ns min	Address Valid to Write Setup Time
$t_2$	15	15	25	ns min	Address Valid to Write Hold Time
$t_3$	60	80	80	ns min	Data Setup Time
$t_4$	25	25	25	ns min	Data Hold Time
$t_5$	0	0	0	ns min	Chip Select or Update to Write Setup Time
$t_6$	0	0	0	ns min	Chip Select or Update to Write Hold Time
$t_7$	80	80	100	ns min	Write Pulse Width
$t_8$	80	80	100	ns min	Clear Pulse Width

Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS\*

( $T_A = +25^\circ\text{C}$  unless otherwise stated)

$V_{DD}$  to DGND .....  $-0.3\text{ V}$ ,  $+17\text{ V}$   
 $V_{REFA}$ ,  $V_{REFB}$  to AGNDA, AGNDB .....  $\pm 25\text{ V}$   
 $V_{RFBA}$ ,  $V_{RFBB}$  to AGNDA, AGNDB .....  $\pm 25\text{ V}$   
 Digital Input Voltage to DGND .....  $-0.3\text{ V}$ ,  $V_{DD} + 0.3\text{ V}$   
 $I_{OUTA}$ ,  $I_{OUTB}$  to DGND .....  $-0.3\text{ V}$ ,  $V_{DD} + 0.3\text{ V}$   
 AGNDA, AGNDB to DGND .....  $-0.3\text{ V}$ ,  $V_{DD} + 0.3\text{ V}$   
 Power Dissipation (Any Package)  
      $T_o + 75^\circ\text{C}$  .....  $450\text{ mW}$   
     Derates Above  $+75^\circ\text{C}$  .....  $6\text{ mW}/^\circ\text{C}$

## Operating Temperature Range

Commercial Plastic (J, K, L Versions) ....  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$   
 Industrial Hermetic (A, B, C Versions) ...  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$   
 Extended Hermetic (S, T, U Versions) ..  $-55^\circ\text{C}$  to  $+125^\circ\text{C}$   
 Storage Temperature .....  $-65^\circ\text{C}$  to  $+150^\circ\text{C}$   
 Lead Temperature (Soldering, 10 sec) .....  $+300^\circ\text{C}$

\*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7537 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

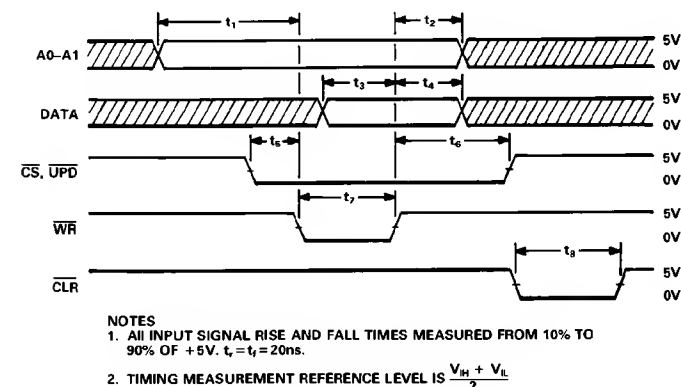


Figure 1. Timing Diagram

## ORDERING GUIDE<sup>1</sup>

Model <sup>2</sup>	Temperature Range	Relative Accuracy	Gain Error	Package Option <sup>3</sup>
AD7537JN	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	$\pm 1\text{ LSB}$	$\pm 6\text{ LSB}$	N-24
AD7537KN	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	$\pm 1/2\text{ LSB}$	$\pm 3\text{ LSB}$	N-24
AD7537LN	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	$\pm 1/2\text{ LSB}$	$\pm 1\text{ LSB}$	N-24
AD7537JP	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	$\pm 1\text{ LSB}$	$\pm 6\text{ LSB}$	P-28A
AD7537KP	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	$\pm 1/2\text{ LSB}$	$\pm 3\text{ LSB}$	P-28A
AD7537LP	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	$\pm 1/2\text{ LSB}$	$\pm 1\text{ LSB}$	P-28A
AD7537AQ	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	$\pm 1\text{ LSB}$	$\pm 6\text{ LSB}$	Q-24
AD7537BQ	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	$\pm 1/2\text{ LSB}$	$\pm 3\text{ LSB}$	Q-24
AD7537CQ	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	$\pm 1/2\text{ LSB}$	$\pm 1\text{ LSB}$	Q-24
AD7537SQ	$-55^\circ\text{C}$ to $+125^\circ\text{C}$	$\pm 1\text{ LSB}$	$\pm 6\text{ LSB}$	Q-24
AD7537TQ	$-55^\circ\text{C}$ to $+125^\circ\text{C}$	$\pm 1/2\text{ LSB}$	$\pm 3\text{ LSB}$	Q-24
AD7537UQ	$-55^\circ\text{C}$ to $+125^\circ\text{C}$	$\pm 1/2\text{ LSB}$	$\pm 2\text{ LSB}$	Q-24
AD7537SE	$-55^\circ\text{C}$ to $+125^\circ\text{C}$	$\pm 1\text{ LSB}$	$\pm 6\text{ LSB}$	E-28A
AD7537TE	$-55^\circ\text{C}$ to $+125^\circ\text{C}$	$\pm 1/2\text{ LSB}$	$\pm 3\text{ LSB}$	E-28A
AD7537UE	$-55^\circ\text{C}$ to $+125^\circ\text{C}$	$\pm 1/2\text{ LSB}$	$\pm 2\text{ LSB}$	E-28A

## NOTES

<sup>1</sup>Analog Devices reserves the right to ship ceramic packages (D-24A) in lieu of cerdip packages (Q-24).

<sup>2</sup>To order MIL-STD-883, Class B processed parts, add/883B to part number. Contact your local sales office for military data sheet.

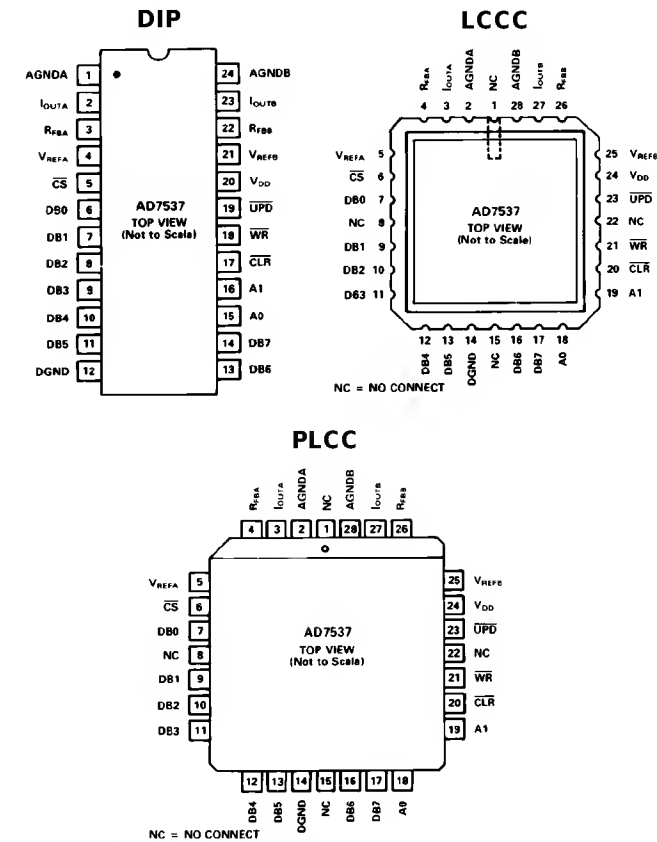
<sup>3</sup>E = Leadless Ceramic Chip Carrier; N = Plastic DIP; P = Plastic Leaded Chip Carrier; Q = Cerdip.

AD7537

PIN FUNCTION DESCRIPTION (DIP)

PIN	MNEMONIC	DESCRIPTION
1	AGNDA	Analog Ground for DAC A.
2	I <sub>OUTA</sub>	Current output terminal of DAC A.
3	R <sub>FBA</sub>	Feedback resistor for DAC A.
4	V <sub>REFA</sub>	Reference input to DAC A.
5	$\overline{\text{CS}}$	Chip Select Input Active low.
6-14	DB0-DB7	Eight data inputs, DB0-DB7.
12	DGND	Digital Ground.
15	A0	Address Line 0.
16	A1	Address Line 1.
17	$\overline{\text{CLR}}$	Clear Input. Active low. Clears all registers.
18	$\overline{\text{WR}}$	Write Input. Active low.
19	$\overline{\text{UPD}}$	Updates DAC Registers from inputs registers.
20	V <sub>DD</sub>	Power supply input. Nominally +12 V to +15 V, with $\pm 10\%$ tolerance.
21	V <sub>REFB</sub>	Reference input to DAC B.
22	R <sub>FBB</sub>	Feedback resistor for DAC B.
23	I <sub>OUTB</sub>	Current output terminal of DAC B.
24	AGNDB	Analog Ground for DAC B.

PIN CONFIGURATIONS



CIRCUIT INFORMATION - D/A SECTION

The AD7537 contains two identical 12-bit multiplying D/A converters. Each DAC consists of a highly stable R-2R ladder and 12 N-channel current steering switches. Figure 2 shows a simplified D/A circuit for DAC A. In the R-2R ladder, binary weighted currents are steered between I<sub>OUTA</sub> and AGNDA. The

current flowing in each ladder leg is constant, irrespective of switch state. The feedback resistor R<sub>FBA</sub> is used with an op amp (see Figures 4 and 5) to convert the current flowing in I<sub>OUTA</sub> to a voltage output.

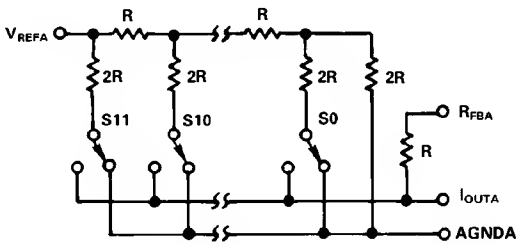


Figure 2. Simplified Circuit Diagram for DAC A

EQUIVALENT CIRCUIT ANALYSIS

Figure 3 shows the equivalent circuit for one of the D/A converters (DAC A) in the AD7537. A similar equivalent circuit can be drawn for DAC B.

C<sub>OUT</sub> is the output capacitance due to the N-channel switches and varies from about 50 pF to 150 pF with digital input code. The current source I<sub>LKG</sub> is composed of surface and junction leakages and approximately doubles every 10°C. R<sub>O</sub> is the equivalent output resistance of the device which varies with input code.

DIGITAL CIRCUIT INFORMATION

The digital inputs are designed to be both TTL and 5 V CMOS compatible. All logic inputs are static protected MOS gates with typical input currents of less than 1 nA.

Table I. AD7537 Truth Table

CLR	UPD	CS	WR	A1	A0	FUNCTION
1	1	1	X	X	X	No Data Transfer
1	1	X	1	X	X	No Data Transfer
0	X	X	X	X	X	All Registers Cleared
1	1	0	0	0	0	DAC A LS Input Register Loaded with DB7-DB0 (LSB)
1	1	0	0	0	1	DAC A MS Input Register Loaded with DB3 (MSB)-DB0
1	1	0	0	1	0	DAC B LS Input Register Loaded with DB7-DB0 (LSB)
1	1	0	0	1	1	DAC B MS Input Register Loaded with DB3 (MSB)-DB0
1	0	1	0	X	X	DAC A, DAC B Registers Updated Simultaneously from Input Registers
1	0	0	0	X	X	DAC A, DAC B Registers are Transparent

NOTES: X = Don't care

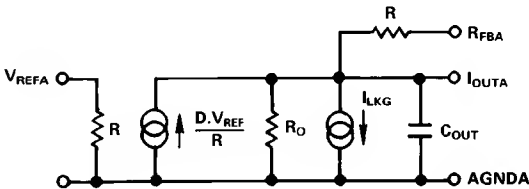


Figure 3. Equivalent Analog Circuit for DAC A

## UNIPOLAR BINARY OPERATION (2-QUADRANT MULTIPLICATION)

Figure 4 shows the circuit diagram for unipolar binary operation. With an ac input, the circuit performs 2-quadrant multiplication. The code table for Figure 4 is given in Table II.

Operational amplifiers A1 and A2 can be in a single package (AD 644, AD 712) or separate packages (AD 544, AD 711, AD OP27). Capacitors C1 and C2 provide phase compensation to help prevent overshoot and ringing when high-speed op amps are used.

For zero offset adjustment, the appropriate DAC register is loaded with all 0s and amplifier offset adjusted so that  $V_{OUTA}$  or  $V_{OUTB}$  is 0 V. Full-scale trimming is accomplished by loading the DAC register with all 1s and adjusting R1 (R3) so that  $V_{OUTA}$  ( $V_{OUTB}$ ) =  $-V_{IN}$  (4095/4096). For high temperature operation, resistors and potentiometers should have a low Temperature Coefficient. In many applications, because of the excellent Gain T.C. and Gain Error specifications of the AD 7537, Gain Error trimming is not necessary. In fixed reference applications, full scale can also be adjusted by omitting R1, R2, R3, R4 and trimming the reference voltage magnitude.

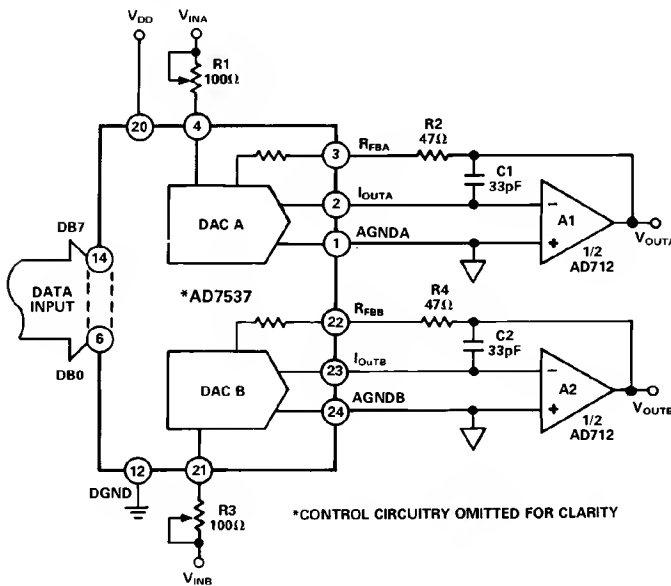


Figure 4. AD7537 Unipolar Binary Operation

Table II. Unipolar Binary Code Table for Circuit of Figure 4

Binary Number in DAC Register MSB      LSB	Analog Output, $V_{OUTA}$ or $V_{OUTB}$
1111 1111 1111	$-V_{IN} \left( \frac{4095}{4096} \right)$
1000 0000 0000	$-V_{IN} \left( \frac{2048}{4096} \right) = -\frac{1}{2} V_{IN}$
0000 0000 0001	$-V_{IN} \left( \frac{1}{4096} \right)$
0000 0000 0000	0 V

## BIPOLAR OPERATION (4-QUADRANT MULTIPLICATION)

The recommended circuit diagram for bipolar operation is shown in Figure 5. Offset binary coding is used.

With the appropriate DAC register loaded to 1000 0000 0000, adjust R1 (R3) so that  $V_{OUTA}$  ( $V_{OUTB}$ ) = 0 V. Alternatively, R1, R2 (R3, R4) may be omitted and the ratios of R6, R7 (R9, R10) varied for  $V_{OUTA}$  ( $V_{OUTB}$ ) = 0 V. Full-scale trimming can be accomplished by adjusting the amplitude of  $V_{IN}$  or by varying the value of R5 (R8).

If R1, R2 (R3, R4) are not used, then resistors R5, R6, R7 (R8, R9, R10) should be ratio matched to 0.01% to ensure gain error performance to the data sheet specification. When operating over a wide temperature range, it is important that the resistors be of the same type so that their temperature coefficients match.

The code table for Figure 5 is given in Table III.

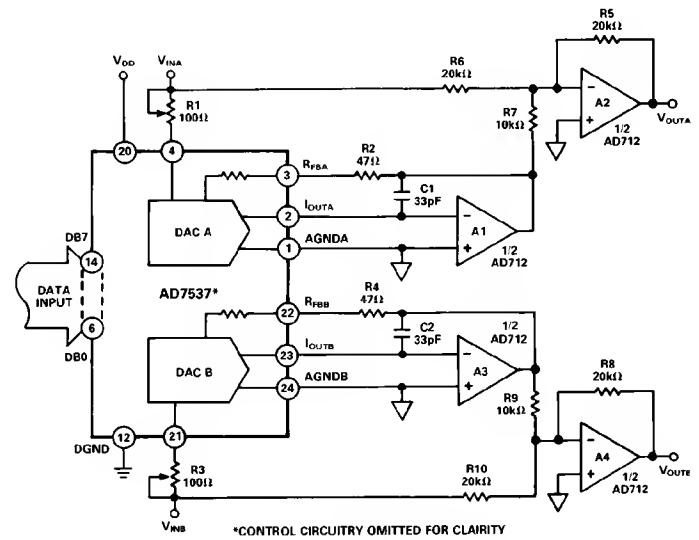


Figure 5. Bipolar Operation (Offset Binary Coding)

Table III. Bipolar Code Table for Offset Binary Circuit of Figure 5

Binary Number in DAC Register MSB      LSB	Analog Output, $V_{OUTA}$ or $V_{OUTB}$
1111 1111 1111	$+V_{IN} \left( \frac{2047}{2048} \right)$
1000 0000 0001	$+V_{IN} \left( \frac{1}{2048} \right)$
1000 0000 0000	0 V
0111 1111 1111	$-V_{IN} \left( \frac{1}{2048} \right)$
0000 0000 0000	$-V_{IN} \left( \frac{2048}{2048} \right) = -V_{IN}$

# AD7537

## SEPARATE AGND PINS

The DACs in the AD7537 have separate AGND lines taken to pins AGNDA and AGNDB on the package. This increases the applications versatility of the part. Figure 6 is an example of this. DAC A is connected in standard fashion as a programmable attenuator. AGNDA is at ground potential. DAC B is operating with AGND B biased to +5 V by the AD584. This gives an output range of +5 V to +10 V.

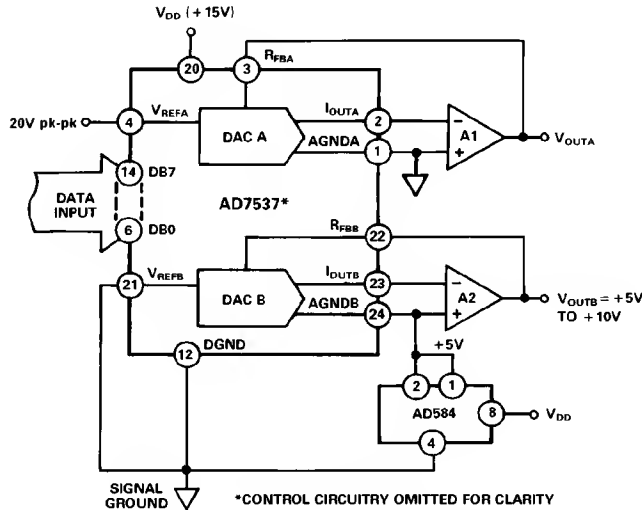


Figure 6. AD7537 DACs Used in Different Modes

## PROGRAMMABLE OSCILLATOR

Figure 7 shows a conventional state variable oscillator in which

the AD7537 controls the programmable integrators. The frequency of oscillation is given by:

$$f = \frac{1}{2\pi} \sqrt{\frac{R_6}{R_5} \times \frac{1}{C_1 \times C_2 \times R_{EQ1} \times R_{EQ2}}}$$

where  $R_{EQ1}$  and  $R_{EQ2}$  are the equivalent resistances of the DACs. The same digital code is loaded into both DACs. If  $C_1 = C_2$  and  $R_5 = R_6$ , the expression reduces to

$$f = \frac{1}{2\pi} \times \frac{1}{C} \sqrt{\frac{1}{R_{EQ1} \times R_{EQ2}}}$$

Since  $R_{EQ} = \frac{2^n \times R_{LAD}}{N}$ , ( $R_{LAD}$  = DAC ladder resistance).

$$\begin{aligned} f &= \frac{1}{2\pi} \times \frac{1}{C} \sqrt{\frac{(N/2^n)^2}{R_{LAD1} \times R_{LAD2}}} \\ &= \frac{1}{2\pi} \times \frac{D}{C} \frac{1}{\sqrt{R_{LAD1} \times R_{LAD2}}} \quad D = \left(\frac{N}{2^n}\right) \\ &= \frac{1}{2\pi} \times \frac{D}{C \times R_{LAD} \sqrt{m}} \end{aligned}$$

where  $m$  is the DAC ladder resistance mismatch ratio, typically 1.005.

With the values shown in Figure 7, the output frequency varies from 0 Hz to 1.38 kHz. The amplitude of the output signal at the A3 output is 10 V peak-to-peak and is constant over the entire frequency span.

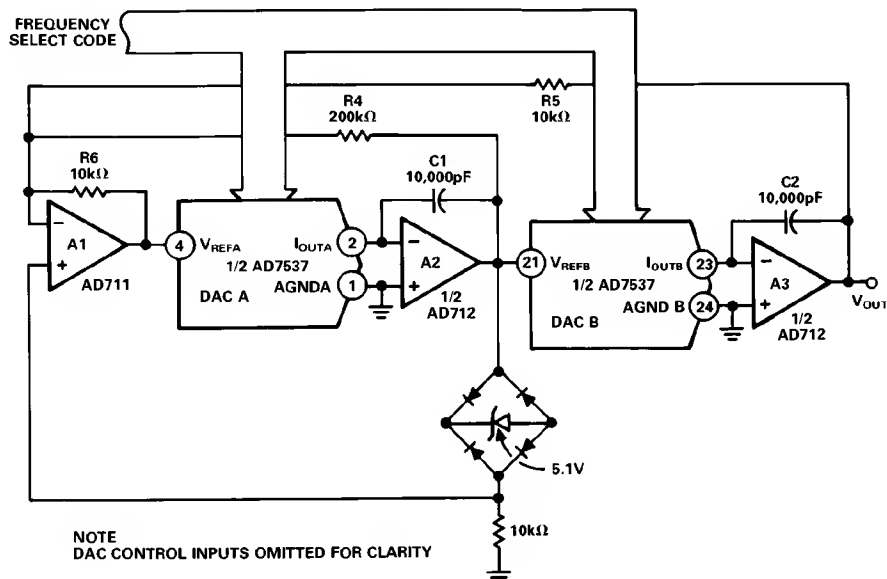


Figure 7. Programmable State Variable Oscillator

## APPLICATION HINTS

**Output Offset:** CMOS D/A converters in circuits such as Figures 4 and 5 exhibit a code dependent output resistance which in turn can cause a code dependent error voltage at the output of the amplifier. The maximum amplitude of this error, which adds to the D/A converter nonlinearity, depends on  $V_{OS}$ , where  $V_{OS}$  is the amplifier input offset voltage. To maintain specified operation, it is recommended that  $V_{OS}$  be no greater than  $(25 \times 10^{-6}) (V_{REF})$  over the temperature range of operation. Suitable op amps are the AD711C and its dual version, the AD712C. These op amps have a wide bandwidth and high slew rate and are recommended for wide bandwidth ac applications. AD711/AD712 settling time to 0.01% is typically 3  $\mu$ s.

**Temperature Coefficients:** The gain temperature coefficient of the AD7537 has a maximum value of 5 ppm/ $^{\circ}$ C and typical value of 1 ppm/ $^{\circ}$ C. This corresponds to worst case gain shifts of 2 LSBs and 0.4 LSBs respectively over a 100 $^{\circ}$ C temperature range. When trim resistors R1 (R3) and R2 (R4) are used to adjust full scale range as in Figure 4, the temperature coefficient of R1 (R3) and R2 (R4) should also be taken into account. For further information see "Gain Error and Gain Temperature Coefficient of CMOS Multiplying DACs", Application Note, Publication Number E630c-5-3/86 available from Analog Devices.

**High Frequency Considerations:** AD7537 output capacitance works in conjunction with the amplifier feedback resistance to add a pole to the open loop response. This can cause ringing or oscillation. Stability can be restored by adding a phase compensation capacitor in parallel with the feedback resistor. This is shown as C1 and C2 in Figures 4 and 5.

**Feedthrough:** The dynamic performance of the AD7537 depends upon the gain and phase stability of the output amplifier, together with the optimum choice of PC board layout and decoupling components. A suggested printed circuit layout for Figure 4 is shown in Figure 8 which minimizes feedthrough from  $V_{REFA}$ ,  $V_{REFB}$  to the output in multiplying applications.

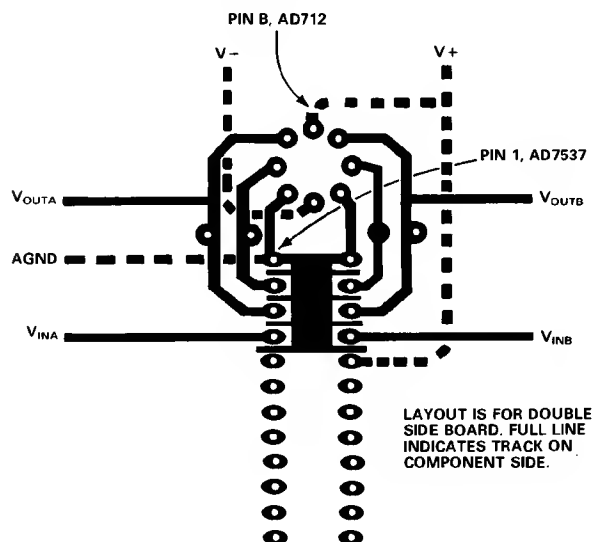


Figure 8. Suggested Layout for AD7537

## MICROPROCESSOR INTERFACING

The byte loading structure of the AD7537 makes it very easy to interface the device to any 8-bit microprocessor system. Figures 9 and 10 show two interfaces: one for the MC6809 and the

other for the MC6808. Figure 11 shows how an AD7537 system can be easily expanded by tying all the  $\overline{UPD}$  lines together and using a single decoder output to control these. This expanded system is shown using a Z80 microprocessor but it is just as easily configured using any other 8-bit microprocessor system. Note how the system shown in Figure 11 produces 4 analog outputs with a minimum amount of hardware.

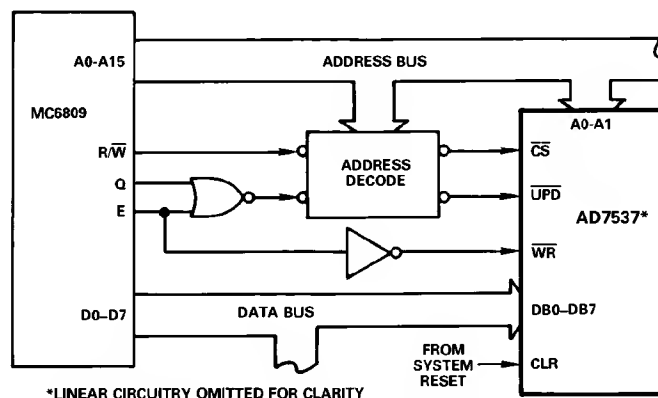


Figure 9. AD7537-MC6809 Interface

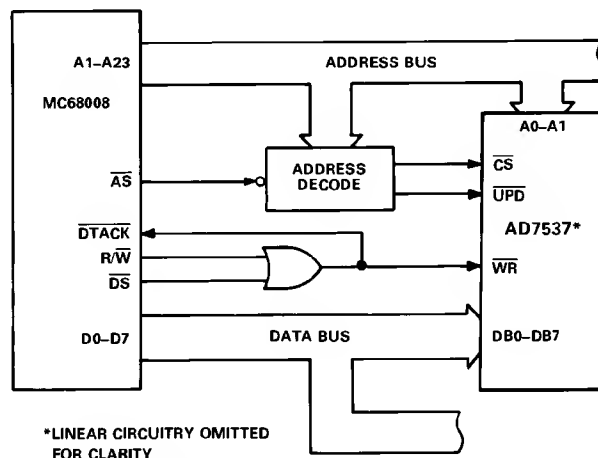


Figure 10. AD7537-MC68008 Interface

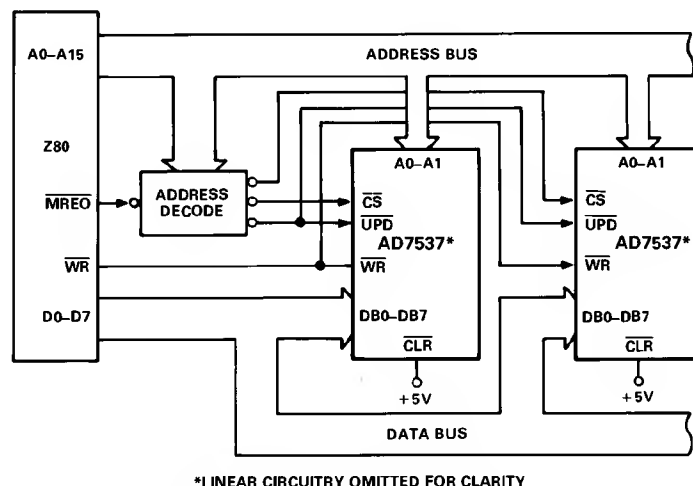
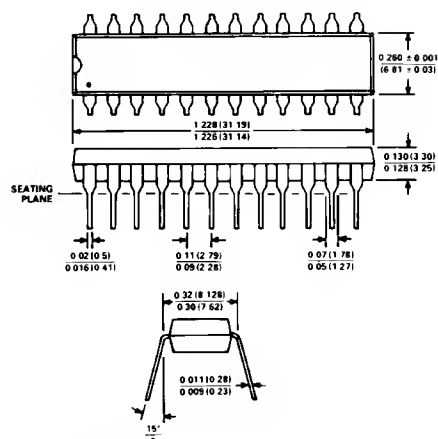


Figure 11. Expanded AD7537 System

## OUTLINE DIMENSIONS

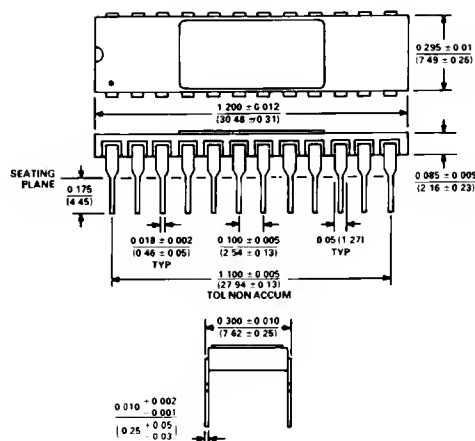
Dimensions shown in inches and (mm).

24-Pin Plastic DIP (N-24)



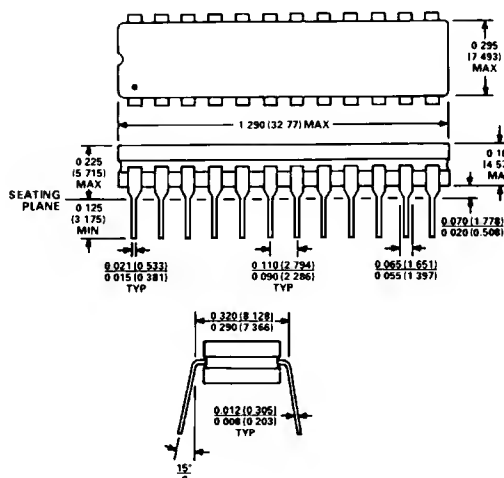
- NOTES
1. LEAD NO. 1 IDENTIFIED BY DOT OR NOTCH
  2. PLASTIC LEADS WILL BE EITHER SOLDER DIPPED OR TIN LEAD PLATED IN ACCORDANCE WITH MIL-M-38510 REQUIREMENTS

24-Pin Ceramic DIP (D-24A)



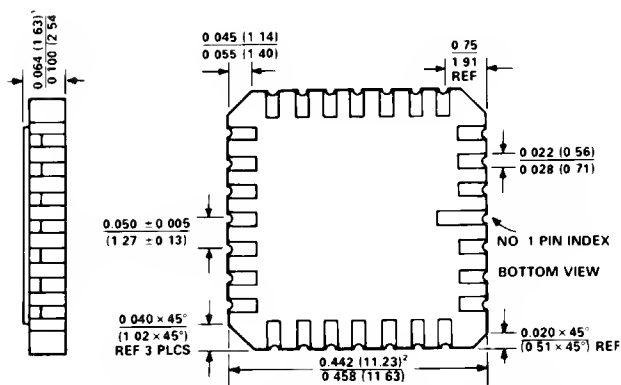
- NOTES
1. LEAD NO. 1 IDENTIFIED BY DOT OR NOTCH
  2. CERAMIC LEADS WILL BE EITHER GOLD OR TIN PLATED IN ACCORDANCE WITH MIL-M-38510 REQUIREMENTS
  3. METAL LID IS CONNECTED TO DGND

24-Pin Cerdip (Q-24)



- NOTES
1. LEAD NO. 1 IDENTIFIED BY DOT OR NOTCH
  2. CERDIP LEADS WILL BE EITHER TIN PLATED OR SOLDER DIPPED IN ACCORDANCE WITH MIL-M-38510 REQUIREMENTS

28-Terminal Leadless Ceramic Chip Carrier (E-28A)



- NOTES
1. THIS DIMENSION CONTROLS THE OVERALL PACKAGE THICKNESS
  2. APPLIES TO ALL FOUR SIDES
  3. ALL TERMINALS ARE GOLD PLATED

28-Terminal Plastic Leaded Chip Carrier (P-28A)

